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# Microfluidic Chip Production v1.1 V.2

Florian De Rop<sup>1,2</sup>, Stein Aerts<sup>1,2</sup>, Suresh Poovathingal<sup>1,2</sup><sup>1</sup>VIB-KU Leuven Center for Brain & Disease Research;<sup>2</sup>Laboratory of Computational Biology, Department of Human Genetics, KU Leuven

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Florian De Rop

Aerts Lab for Computational Biology, VIB/KU Leuven Centre fo...

## ABSTRACT

Protocol for producing microfluidic chips used in HyDrop experiment.

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## Microfluidic Chip Preparation

### 1 Producing an SU-8 patterned silicon wafer

Here, we describe how we produce our microfluidic chips. The most important part is that the x/y dimensions of your droplet generators match ours. The z-dimension (channel height) may vary according to your method of spin-coating and the viscosity of your photoresist. We aim for a height of 70 to 80 micrometers. Deviations from this height will lead to different droplet sizes. If your final wafer has a slightly higher or lower height, you may be able to adjust the flow rates during microfluidic operation to account for this difference.

#### 1.1

Create a chrome UV mask design using the following chip designs:

The design on the left is the hydrogel bead generator, the design on the left is a cell encapsulation chip used for both HyDrop-ATAC and -RNA.

We bond our PDMS chips to regular 3 by 1 inch glass microscopy slides. Therefore, our mask design consists of several groups of 5-7 parallel copies of the microfluidic design, filling a 4 inch wafer. After wafer production, we place a small rectangular plastic "dike" onto the patterned wafer and pour the PDMS into the dike. This results in a PDMS slab that has 7 copies of the design and will fit perfectly onto a 3 by 1 inch glass microscopy slide.

- 1.2 Prepare your photoresist mixture. We use SU 8-2050 (Microchem) negative photoresist.
- 1.3 Spin coat your wafer to a layer height of 70 to 80  $\mu\text{m}$ . In our case, we use 4 inch wafers and spin at 500 rpm (ramp 100rpm/s) - 10s and 2000 rpm (ramp: 300rpm/s) - 30s, to achieve a feature height of 70-80  $\mu\text{m}$ . Deviations from height may result in different droplet size and encapsulation statistics.
- 1.4 Bake and clean your wafer per the recommendations of your photoresist's manufacturer.

## 2 PDMS Chip production

Pouring and baking of PDMS

- 2.1 Mix PDMS and curing agent (Dow Corning SYLGARD 184) at a ratio of 10 to 1. Mix thoroughly, and put under near-vacuum for 45 minutes. This will remove small air bubbles. Meanwhile, pre-heat an oven at 80  $^{\circ}\text{C}$
- 2.2 Inspect your SU-8 patterned wafer for any dust or imperfections and place a rectangular PMMA (or other non-reactive plastic) dike around the patterned imprint to hold the PDMS. Check if no bubbles remain in the PDMS. Pour the PDMS into the PMMA holder/dike onto the wafer.

Tip: you can pour leftover PDMS mix into a cell culture plate to create a PDMS mat. This PDMS mat can be used later during punching of holes through the PDMS chip.

Bake in oven for 4 hours (or at the shortest 2 hours) at 80  $^{\circ}\text{C}$

- 2.3 Remove PDMS slab from mold and tape over features to prevent dust accumulation  
Puncture inlet holes with 1 mm biopsy needles. Perform this action while holding the PDMS chip on your PDMS mat to prevent biopsy needle blunting.

Tip: when you puncture the slabs, do so at a slight angle so that the tube that you will connect through that hole will face slightly outward, away from the centre of the chip. This ensures that the tube or pipet tip will not block your microscope's light source.

## 3 Plasmabonding

Bonding the PDMS chip to a glass slide. We use regular 3 by 1 inch microscopy slides. This protocol was written for our lab's setup, but the procedures we use are quite standard. It is possible that microfluidics expertise units use a slightly different method, which is also more than likely fine. The end result needs to be a tightly sealed transparent microfluidic chip of which the channels are hydrophobic.

- 3.1 Put glass slide into 50 mL falcon and add 1 mL of acetone.  
Shake well  
Wipe glass plate dry with dust-free cloth
- 3.2 Clean the surface of your PDMS chip by repeatedly using a piece of tape to collect any dust
- 3.3 Put glass microscopy slide on the glass plasma bonder plate  
Put chip with features facing up on the glass plasma bonder plate  
Vacuum glass + PDMS chip in plasma bonder until the pressure is stable under 1 mmHg  
Put plasma on HIGH for 30 seconds  
Turn off plasma bonder and take out the plate  
Quickly, press the PDMS slab firmly onto the glass plate.  
Press down well using flat object.  
Check for any possible delamination
- 3.4 Immediately after plasma bonding, flow 10 uL of silane in HFE (2%) through the channels  
Wet all channels quickly  
Blow out all oil in channels using the air gun.
- 3.5 Bake 4h @ 100 °C and store the finished chips with tape covering the inlets.